Texas Instruments Inc.

WL1835MODCOM8B
WL1835MODGB COM8 Card

History Change

<table>
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<tr>
<th>Revision</th>
<th>Date</th>
<th>Description</th>
<th>Prepared By</th>
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<td>D01</td>
<td>2013.09.04</td>
<td>New release</td>
<td>Hsinwei Wang</td>
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Texas Instruments

Title Page

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